

P-Channel Enhancement Mode Power MOSFET

Description

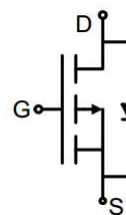
The G100P04K uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.

General Features

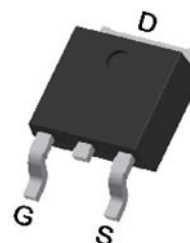
- V_{DS} -40V
- I_D (at $V_{GS} = -10V$) -55A
- $R_{DS(ON)}$ (at $V_{GS} = -10V$) < 10m Ω
- $R_{DS(ON)}$ (at $V_{GS} = -4.5V$) < 15m Ω
- 100% Avalanche Tested
- RoHS Compliant

Application

- Power switch
- DC/DC converters



Schematic diagram



TO-252

Device	Package	Marking	Packaging
G100P04K	TO-252	45P40	2500pcs/Reel

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-40	V
Continuous Drain Current	I_D	-55	A
		-35	
Pulsed Drain Current (note1)	I_{DM}	-220	A
Gate-Source Voltage	V_{GS}	± 20	V
Power Dissipation	P_D	58	W
Single pulse avalanche energy (note2)	E_{AS}	132	mJ
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	$^\circ\text{C}$

Thermal Resistance

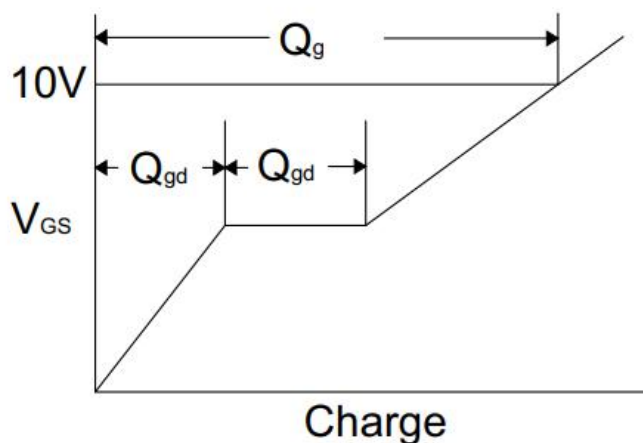
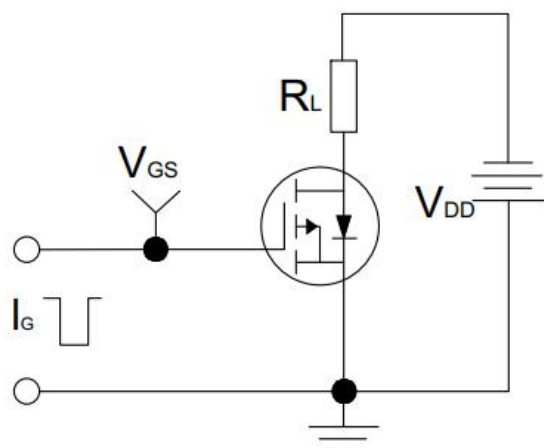
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	50	$^\circ\text{C/W}$
Maximum Junction-to-Case	R_{thJC}	2.14	$^\circ\text{C/W}$

Specifications T _J = 25°C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-40	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -40V, V _{GS} = 0V	--	--	-1	μA
Gate-Source Leakage	I _{GSS}	V _{GS} = ±20V	--	--	±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-1.2	-1.8	-2.5	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = -10V, I _D = -20A	--	8.5	10	mΩ
		V _{GS} = -4.5V, I _D = -20A	--	12.5	15	
Forward Transconductance	g _{FS}	V _{DS} = -5V, I _D = -20A	--	33	--	S
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = -20V, f = 1.0MHz	--	2500	--	pF
Output Capacitance	C _{oss}		--	335	--	
Reverse Transfer Capacitance	C _{rss}		--	292	--	
Total Gate Charge	Q _g	V _{DD} = -20V, I _D = -20A, V _{GS} = -10V	--	58	--	nC
Gate-Source Charge	Q _{gs}		--	7	--	
Gate-Drain Charge	Q _{gd}		--	14	--	
Turn-on Delay Time	t _{d(on)}	V _{DD} = -20V, I _D = -20A, R _G = 3Ω	--	9	--	ns
Turn-on Rise Time	t _r		--	7	--	
Turn-off Delay Time	t _{d(off)}		--	19	--	
Turn-off Fall Time	t _f		--	9	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I _S	T _C = 25°C	--	--	-55	A
Body Diode Voltage	V _{SD}	T _J = 25°C, I _{SD} = -20A, V _{GS} = 0V	--	--	-1.2	V
Reverse Recovery Charge	Q _{rr}	I _F = -20A, V _{GS} = 0V di/dt=-100A/us	--	36	--	nC
Reverse Recovery Time	T _{rr}		--	21	--	ns

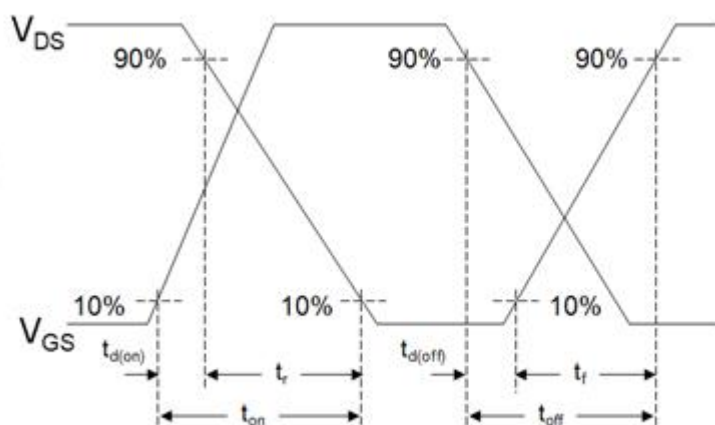
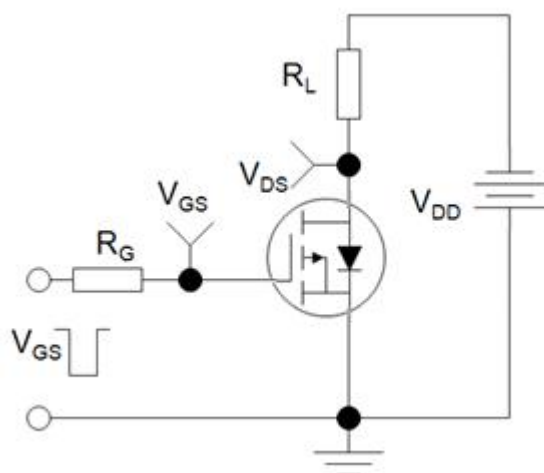
Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. EAS condition : $T_J = 25^{\circ}\text{C}, V_{DD} = -40V, V_{GS} = -10V, L = 0.5mH, R_g = 25\Omega$
The table shows the minimum avalanche energy, which is 360mJ when the device is tested until failure
3. Identical low side and high side switch with identical R_G

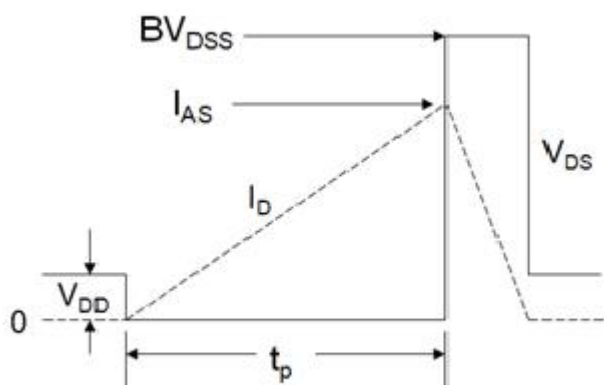
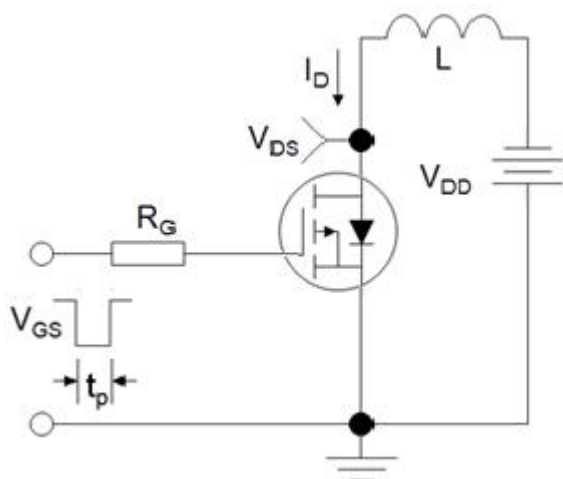
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

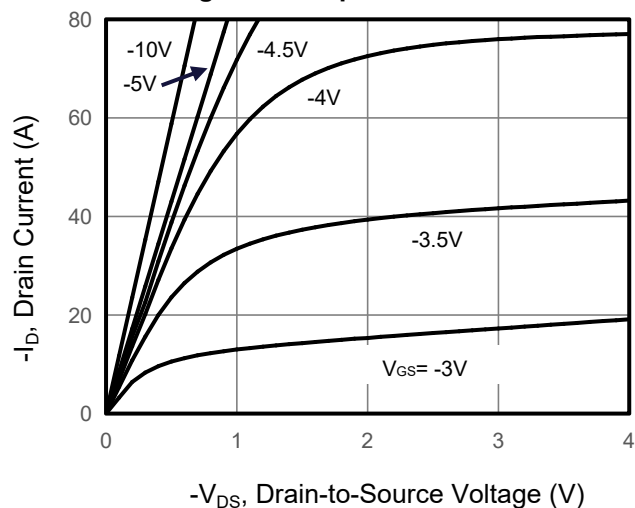


Figure 2. Transfer Characteristics

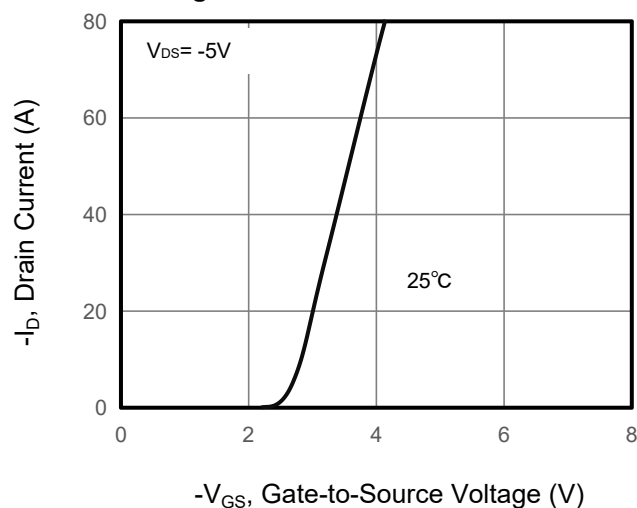


Figure 3. Drain Source On Resistance

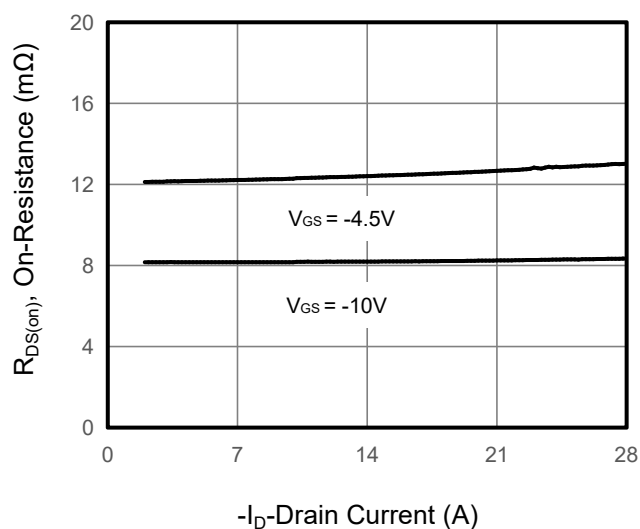


Figure 4. Gate Charge

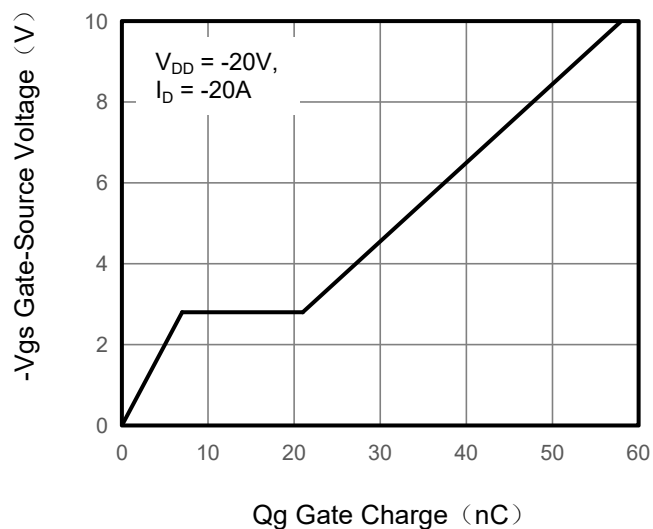


Figure 5. Capacitance

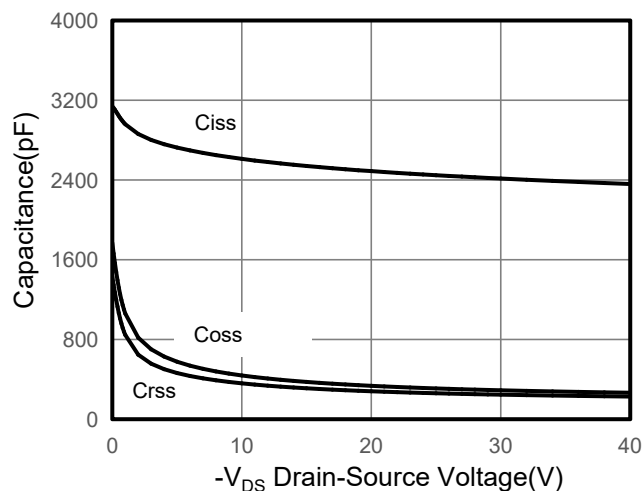
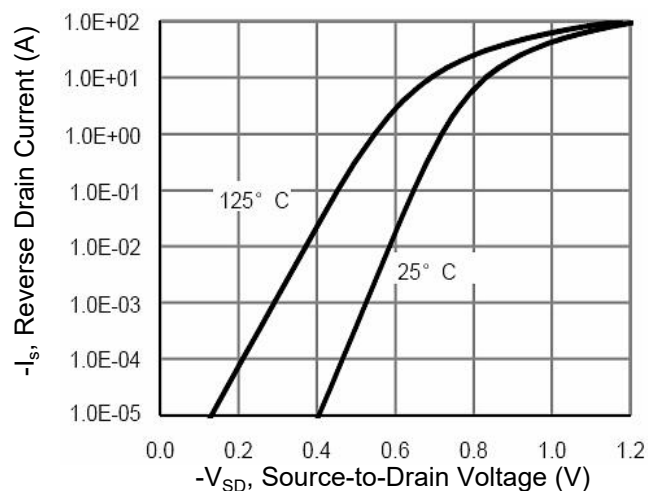


Figure 6. Source-Drain Diode Forward



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

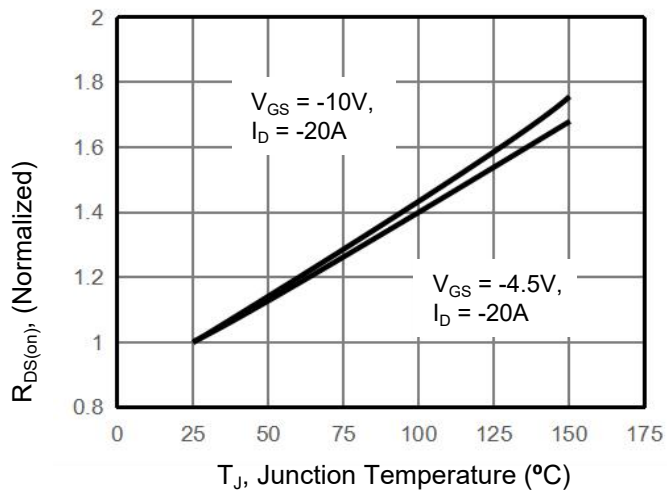


Figure 8. Safe Operation Area

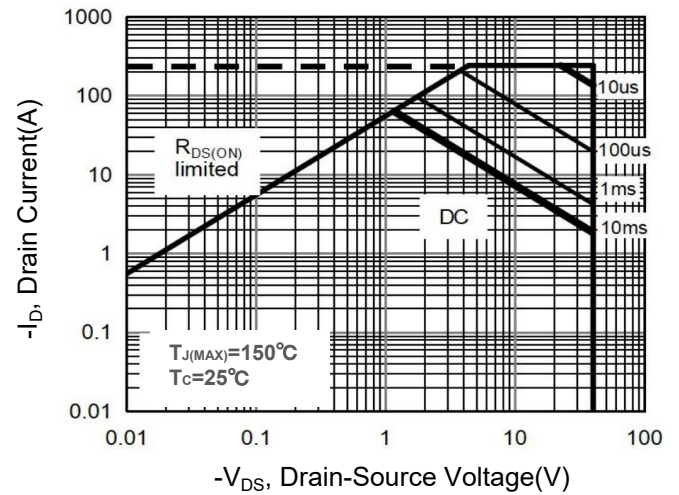


Figure 9. Maximum Continuous Drain Current vs Case Temperature

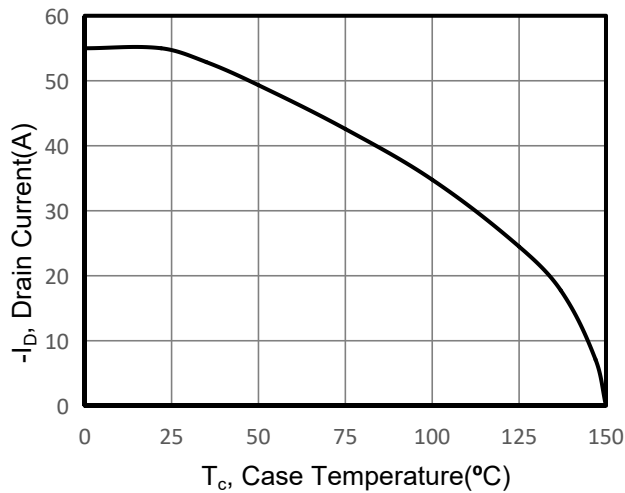
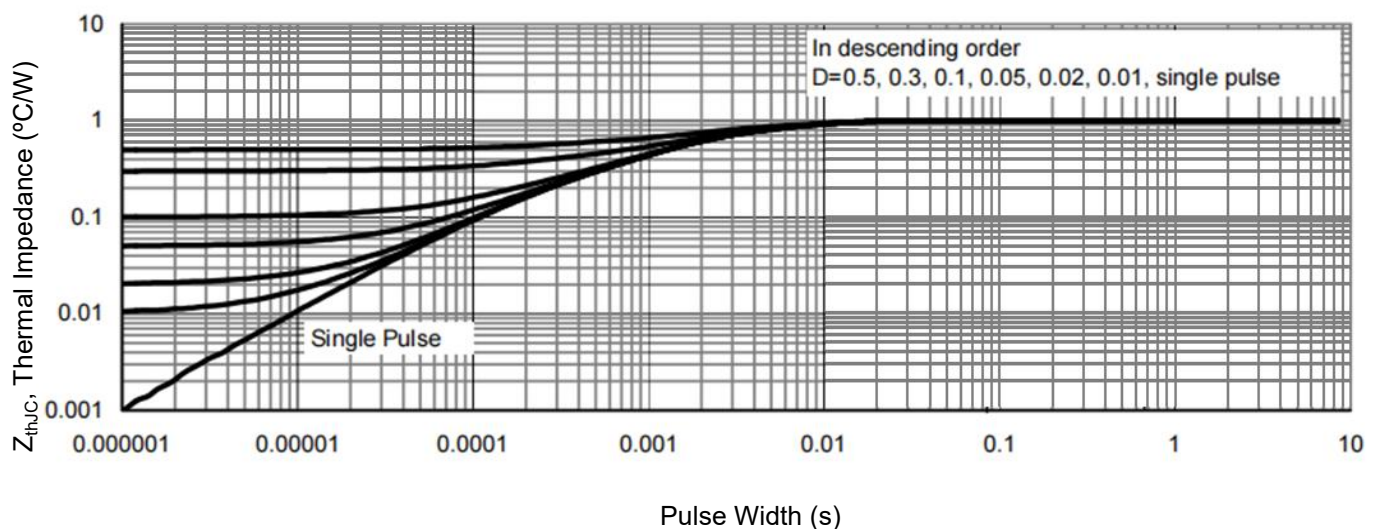
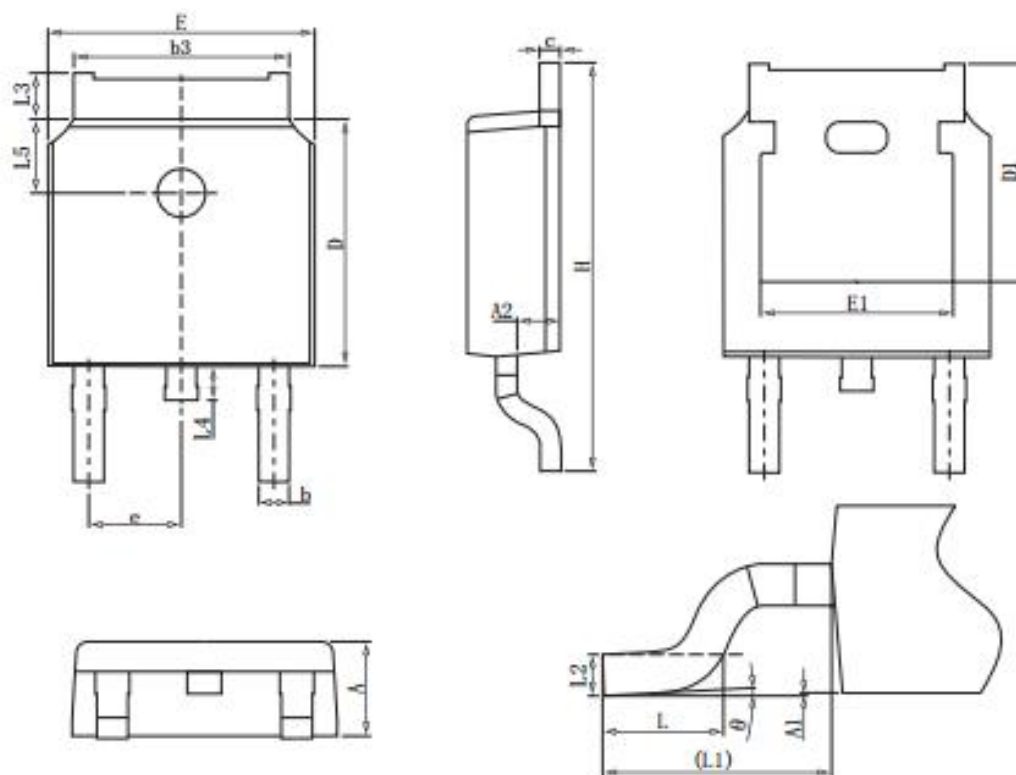


Figure 10. Normalized Maximum Transient Thermal Impedance



TO-252 Package Information



Symbol	Dimensions in Millimeters		
	MIN.	NOM.	MAX.
A	2.2	2.3	2.4
A1	0		0.2
A2	0.97	1.07	1.17
b	0.68	0.78	0.9
b3	5.2	5.33	5.5
c	0.43	0.53	0.63
D	5.98	6.1	6.22
D1	5.30REF		
E	6.4	6.6	6.8
E1	4.63		
e	2.286BSC		
H	9.4	10.1	10.5
L	1.38	1.5	1.75
L1	2.90REF		
L2	0.51BSC		
L3	0.88		1.28
L4	0.5		1
L5	1.65	1.8	1.95
θ	0°		8°